

PSMN6R8-40HS

N-channel 40 V, 6.8 mOhm, standard level MOSFET in LFPAK56D using TrenchMOS technology

19 October 2022

Product data sheet

1. General description

Dual standard level N-channel MOSFET in an LFPAK56D (Dual Power-SO8) package using TrenchMOS technology.

2. Features and benefits

- Dual MOSFET
- Repetitive avalanche rated
- · High reliability LFPAK56D package
- · Copper-clip, solder die attach
- Qualified to 175 °C

3. Applications

- Brushless DC motor control
- DC-to-DC converters
- · High-performance synchronous rectification
- · High performance and high efficiency server power supply

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	40	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	40	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	64	W
T _j	junction temperature			-55	-	175	°C
Static chara	acteristics FET1 and FET2						
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_{D} = 20 A; T_{j} = 25 °C; Fig. 12		-	5.8	6.8	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 175 °C; Fig. 12; Fig. 13		-	11	13.4	mΩ
Dynamic ch	haracteristics FET1 and FE	T2				-	
Q_{GD}	gate-drain charge	I _D = 20 A; V _{DS} = 32 V; V _{GS} = 20 V; T _j = 25 °C; <u>Fig. 14</u> ; <u>Fig. 15</u>		-	9.1	-	nC
Q _{G(tot)}	total gate charge	I _D = 20 A; V _{DS} = 32 V; V _{GS} = 10 V; T _j = 25 °C; <u>Fig. 14</u> ; <u>Fig. 15</u>		-	28.9	-	nC
Avalanche	ruggedness FET1 and FET	2					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$I_D = 40 \text{ A}; V_{sup} \le 40 \text{ V}; V_{GS} = 10 \text{ V};$ $T_{j(init)} = 25 \text{ °C}; Fig. 4$	[1] [2]	-	-	130	mJ



Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-drain d	iode FET1 and FET2					
Q _r		I_S = 20 A; dI_S/dt = -100 A/ μ s; V_{GS} = 0 V; V_{DS} = 20 V; T_j = 25 °C	-	11.3	-	nC

- [1] Refer to application note AN10273 for further information
- [2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	S1	source1	8 7 6 5		
2	G1	gate1		D1 D1 D2 D2	
3	S2	source2			
4	G2	gate2			
5	D2	drain2			
6	D2	drain2			
7	D1	drain1		S1 G1 S2 G2	
8	D1	drain1	LFPAK56D; Dual LFPAK (SOT1205)	mbk725	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN6R8-40HS	· ·	plastic, single ended surface mounted package (LFPAK56D); 8 leads	SOT1205			

7. Marking

Table 4. Marking codes

Type number	Marking code
PSMN6R8-40HS	6R8S40H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	40	V
V_{DGR}	drain-gate voltage	25 °C ≤ T_j ≤ 175 °C; R_{GS} = 20 kΩ	-	40	V
V_{GS}	gate-source voltage	DC; T _j ≤ 175 °C	-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	64	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	40	A
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>	-	40	А

Symbol	Parameter	Conditions		Min	Max	Unit
I _{DM}	peak drain current	pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 °C$; Fig. 3		-	276	А
T _{stg}	storage temperature			-55	175	°C
T _j	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drain	n diode FET1 and FET2			•	•	
Is	source current	T _{mb} = 25 °C		-	40	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 °C$		-	276	А
Avalanche ru	uggedness FET1 and FET2			•		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$I_D = 40 \text{ A; } V_{sup} \le 40 \text{ V; } V_{GS} = 10 \text{ V;}$ $T_{j(init)} = 25 \text{ °C; } Fig. 4$	[1] [2]	-	130	mJ

- [1] Refer to application note AN10273 for further information
- [2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

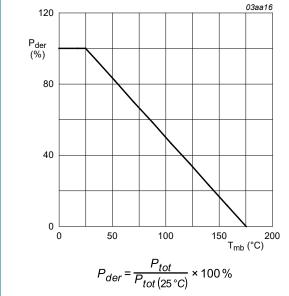
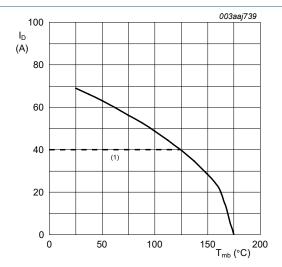
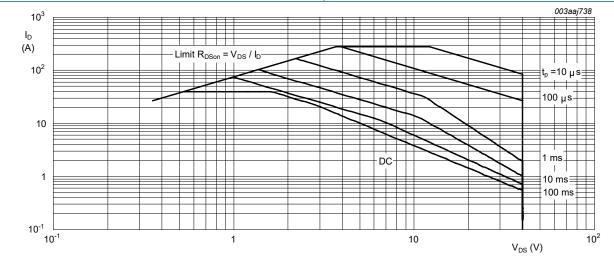


Fig. 1. Normalized total power dissipation as a function of mounting base temperature



 V_{GS} 10 \geq V; (1) Capped at 40 A due to package.

Fig. 2. Continuous drain current as a function of mounting base temperature



T_{mb} = 25 °C; I_{DM} is a single pulse; (1) Capped at 40 A due to package.

Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

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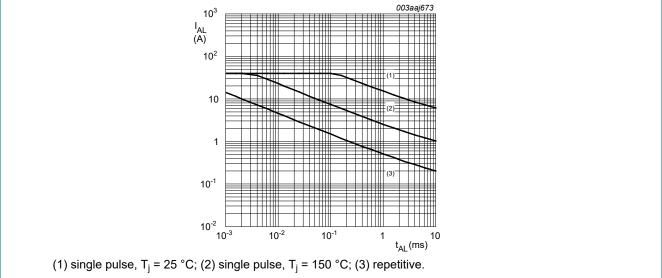
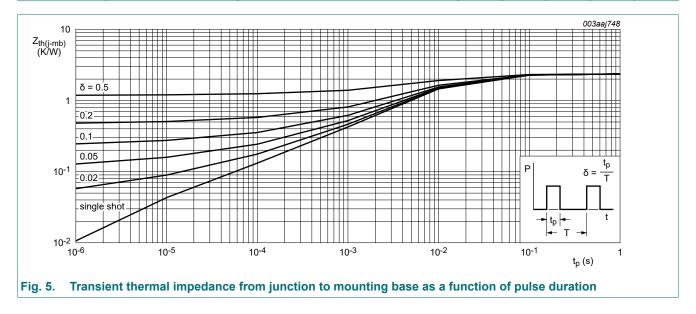


Fig. 4. Single-pulse and repetitive avalanche rating; avalanche current as a function of avalanche time, FET1 and FET2

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	2.36	K/W
$R_{th(j-a)}$		Minimum footprint; mounted on a printed circuit board	-	95	-	K/W



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics FET1 and FET2					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	36	-	-	V
, ,	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C	40	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 25 °C; <u>Fig. 10</u> ; <u>Fig. 11</u>	2.4	3	4	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 10; Fig. 11	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ Fig. 10; Fig. 11	-	-	4.5	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μΑ
		V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μΑ
I _{GSS} gate	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
Doon	drain-source on-state resistance	V_{GS} = 10 V; I_D = 20 A; T_j = 25 °C; Fig. 12	-	5.8	6.8	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 175 °C; Fig. 12; Fig. 13	-	11	13.4	mΩ
Dynamic ch	naracteristics FET1 and FE	T2	'	-		'
Q _{G(tot)}	total gate charge	I _D = 20 A; V _{DS} = 32 V; V _{GS} = 10 V;	-	28.9	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	7	-	nC
Q_{GD}	gate-drain charge	I _D = 20 A; V _{DS} = 32 V; V _{GS} = 20 V; T _j = 25 °C; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	9.1	-	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz;	-	1460	1947	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 16</u>	-	324	389	pF
C _{rss}	reverse transfer capacitance		-	197	270	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 32 \text{ V}; R_L = 1.6 \Omega; V_{GS} = 10 \text{ V};$	-	8.9	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	15.4	-	ns
t _{d(off)}	turn-off delay time	1	-	19.4	-	ns
t _f	fall time	1	-	16.5	-	ns
Source-dra	in diode FET1 and FET2					1
V _{SD}	source-drain voltage	I _S = 10 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 17</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	$I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V};$	-	20.6	-	ns
Q _r	recovered charge	V _{DS} = 20 V; T _j = 25 °C	-	11.3	_	nC

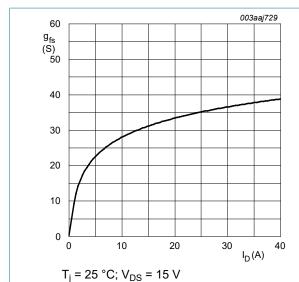


Fig. 6. Forward transconductance as a function of drain current; typical values

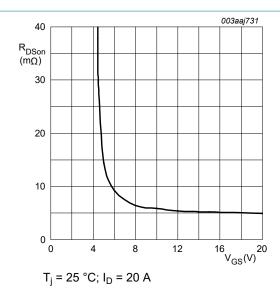


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

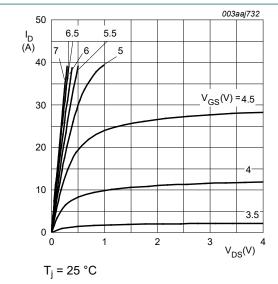


Fig. 8. Output characteristics: drain current as a function of drain-source voltage; typical values

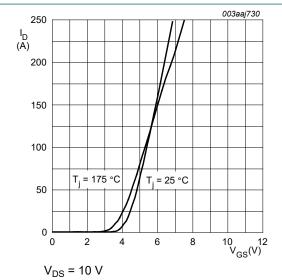


Fig. 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values

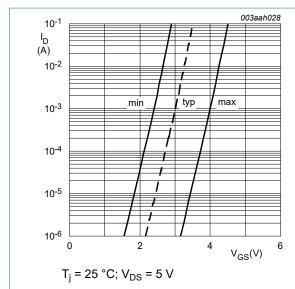


Fig. 10. Sub-threshold drain current as a function of gate-source voltage

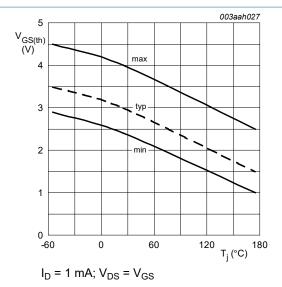


Fig. 11. Gate-source threshold voltage as a function of junction temperature

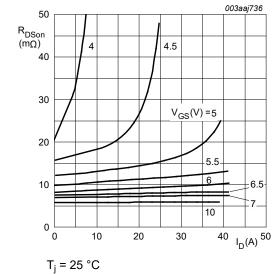


Fig. 12. Drain-source on-state resistance as a function of drain current; typical values

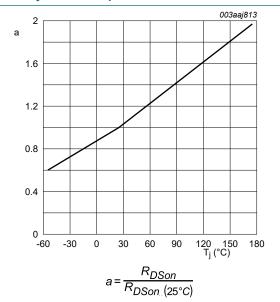


Fig. 13. Normalized drain-source on-state resistance factor as a function of junction temperature

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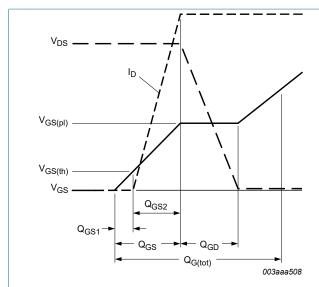


Fig. 14. Gate charge waveform definitions

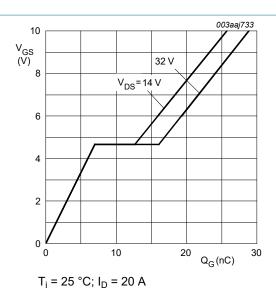


Fig. 15. Gate-source voltage as a function of gate charge; typical values

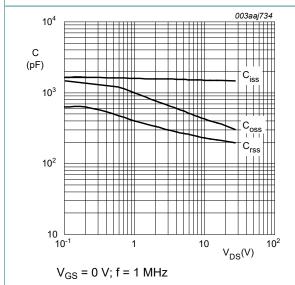
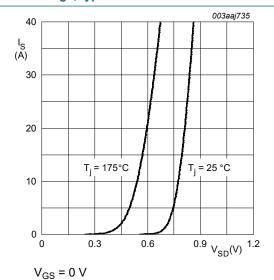


Fig. 16. Input, output and reverse transfer capacitances | Fig. 17. Source current as a function of source-drain as a function of drain-source voltage; typical values



voltage; typical values

11. Package outline

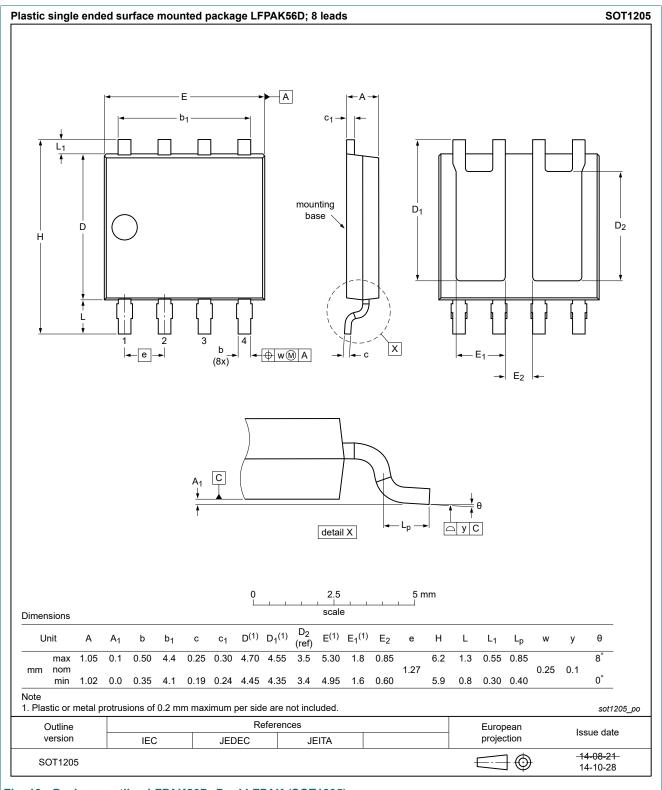
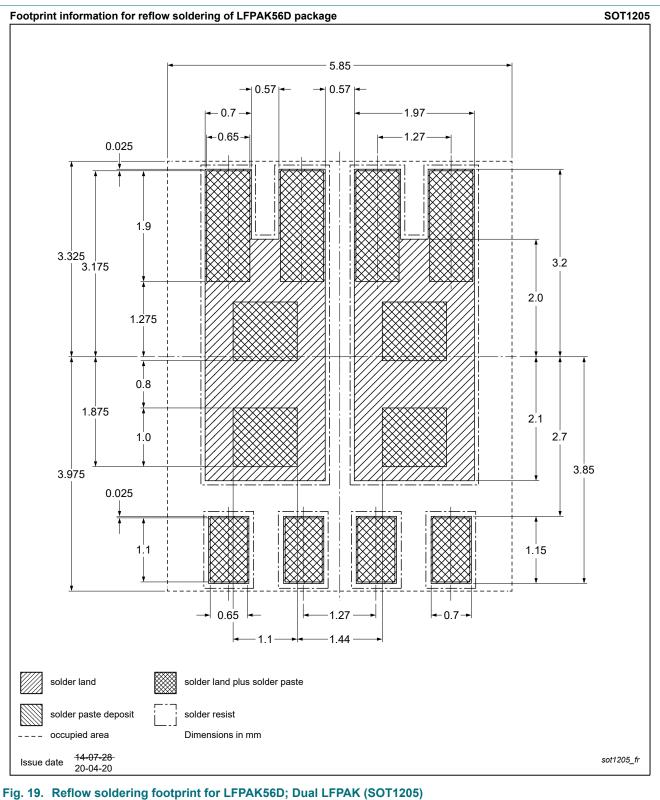


Fig. 18. Package outline LFPAK56D; Dual LFPAK (SOT1205)

12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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